

Product Specification: SP0102 Series (Generation II)

This document applies the following SiSonic Model Numbers:

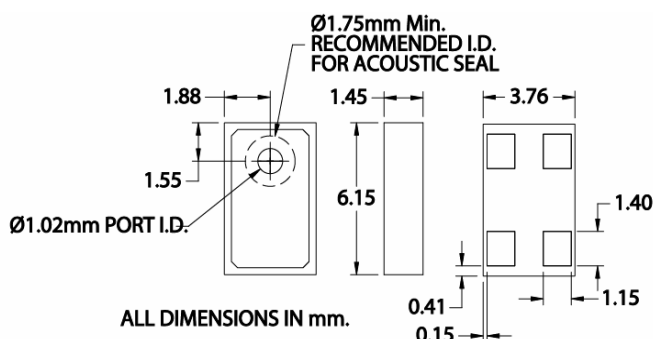
SP0102NC3-2

SP0102NC3-3

SiSonic microphone was developed as a cost effective alternative to traditional electret condenser microphones. Provided on tape-and-reel, SiSonic is ideally suited for high volume applications. It can be processed directly to a customer's PCB using standard automatic pick-and-place equipment, and surface mounted via standard solder reflow equipment.

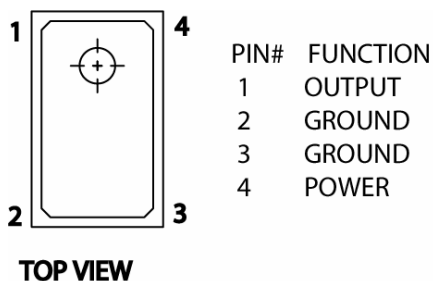


Microphone Dimensional Layout

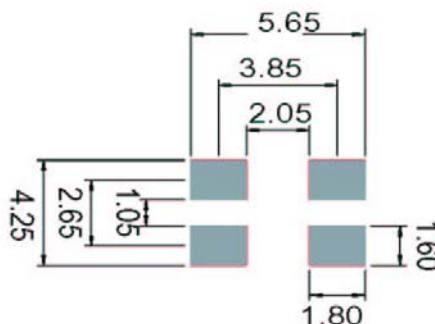


Item	Dim.	Tol. (+/-)	Units
Height	1.45	0.15	mm
Length	6.15	0.05	mm
Width	3.76	0.05	mm
Long Edge to C.L. Port	1.88	0.25	mm
Short Edge to C.L. Port	1.55	0.25	mm
Weight	~0.09	grams	
Coplanarity	< 0.1		mm

Microphone Pin Output



Recommended PCB Land Layout

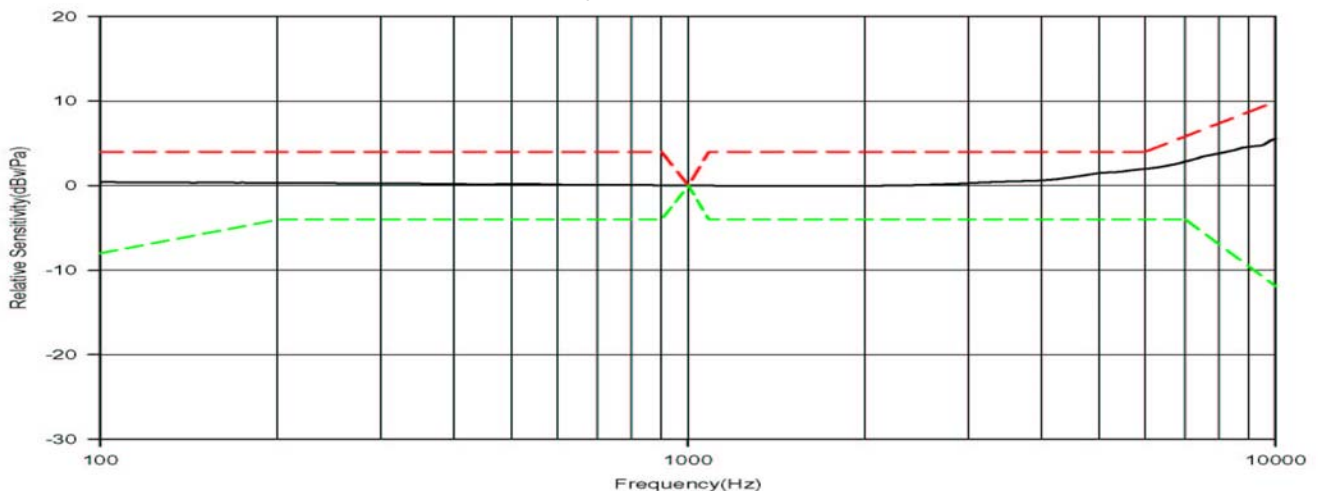


Product Specifications

Test Conditions: +20°C, 60-70% R.H.

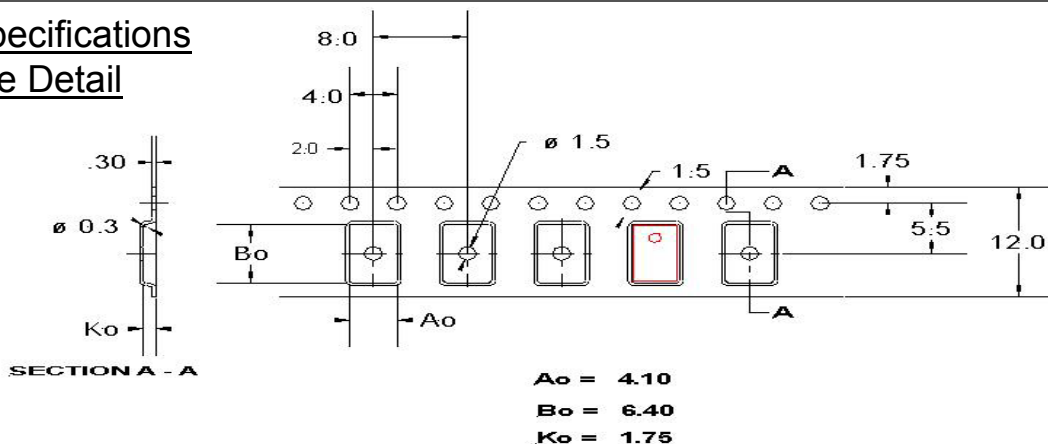
	Symbol	Condition	Limits			Unit
			Min.	Nom.	Max.	
Directivity		Omni-directional				
Sensitivity	S	@ 1kHz (0dB=1V/Pa)	-46	-42	-38	dB
Output impedance	Z _{OUT}	@ 1kHz (0dB=1V/Pa)			100	Ω
Current Consumption	I _{DSS}	across 1.5 to 5.5 volts	0.100		0.250	mA
Signal to Noise Ratio	S/N	@ 1kHz (0dB=1V/Pa)	55	59		dB
Typical Input Referred Noise	ENL	A-weighted		35		dBA SPL
Supply Voltage	Vs		1.5		5.5	V
Sensitivity Loss across Voltage		Change in sensitivity over 5.5v to 1.5v	No Change Across Voltage Range			dB
Maximum Input Sound Level		At 100dB SPL, THD < 1% At 115dB SPL, THD = < 10%				dB
Operating Temperature			-40		+100	°C
Storage Temperature			-40		+100	°C
Frequency Range		100 – 10,000				Hz

Frequency Response Curve



Packaging Specifications

Carrier – Tape Detail



Model Number	Suffix	Reel Diameter	Qty per Reel	Capacitor Config.
SP0102NC3	-2	7"	1,200	10 & 33pF
SP0102NC3	-3	13"	4,500	10 & 33pF

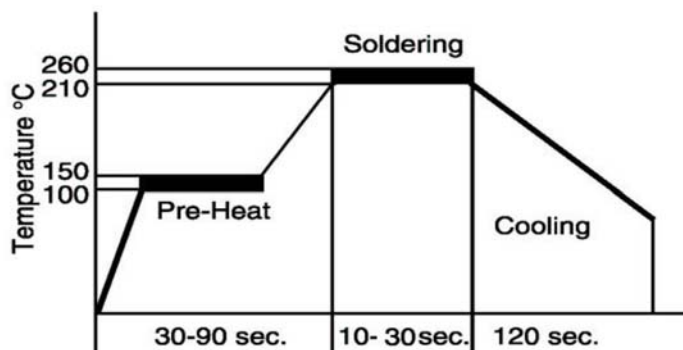
NOTE: All devices are lead-free and compatible with lead-free reflow profile.

Tape & Reel	Available in 7" or 13" diameter.
Leader Length	800mm or minimum of 100 empty pockets
Label	Label applied to external package and direct to reel. Per JEDEC.
Storage Life	1 year storage (original packaging, low humidity)
Polarity of part	"L" – direction

Solderability Characteristics

Solder Reflow	260°C for maximum 30 seconds
Conditions:	Do not board wash after reflow. Do not pull vacuum directly over acoustic port hole.

Reflow Profile
(Maximum Conditions)



Reliability

Note: After test conditions are performed, the sensitivity of the microphone shall not deviate more than 3dB from its initial value.

Thermal Shock	Microphone unit must operate when exposed to air-to-air thermal shock 100 cycles, from –40°C to +125°C. (IEC 68-2-4),
High Temperature Storage Test	Microphone unit must maintain sensitivity after storage at +105°C for 1,000 hours. (IEC 68-2-2 Test Ba)
Low Temperature Storage Test	Microphone unit must maintain sensitivity after storage at –40°C for 1,000 hours. (IEC 68-2-1 Test Aa)
High Temperature Operating Test	Microphone unit must operate within sensitivity specifications for 16 hours at 105°C. (IEC 68-2-2 Test Ba)
Low Temperature Operating Test	Microphone unit must operate within sensitivity specifications for 16 hours at –40°C. (IEC 68-2-1 Test Aa)
Humidity Test	Tested under Bias at 85°C/85% R.H. for 270 hours. (JESD22-A101A-B)
Vibration Test	Microphone unit must operate under test condition: 4 cycles, from 20 to 2,000 Hz in each direction (x,y,z), 48 minutes, using peak acceleration of 20g (+20%, -0%). (MIL 883E, method 2007.2, A)
Electrostatic Discharge	Tested to 8kV direct contact discharge or 15kV air discharge as specified by IEC 1000-4-2, level 3 and level 4.
Reflow	Microphone is tested to 5 passes through reflow oven under conditions of 260°C for 30 seconds maximum.
Mechanical Shock	Tested to 5,000g (IEC 68-2-27, Ea).

Recommended Interface Circuit

